

SN54ALVTH16821, SN74ALVTH16821 2.5-V/3.3-V 20-BIT BUS-INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

SCES078A – JULY 1996 – REVISED JULY 1996

- Members of the Texas Instruments **Widebus™** Family
- High-Impedance State During Power Up and Power Down
- 5-V I/O Compatible
- High-Drive Capability (–32 mA/64 mA)
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Auto 3-State Eliminates Bus Current Loading When Voltage at the Output Exceeds V_{CC}
- Bus-Hold Data Inputs Eliminate the Need for External Pullup/Pulldown Resistors
- Power Off Disables Inputs/Outputs, Permitting Live Insertion
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages, and 380-mil Fine-Pitch Ceramic Flat (WD) Package

description

The 'ALVTH16821 are 20-bit bus-interface flip-flops with 3-state outputs designed for 2.5-V or 3.3-V V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

The 'ALVTH16821 can be used as two 10-bit flip-flops or one 20-bit flip-flop. The 20 flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK), the flip-flops store the logic levels set up at the Q outputs.

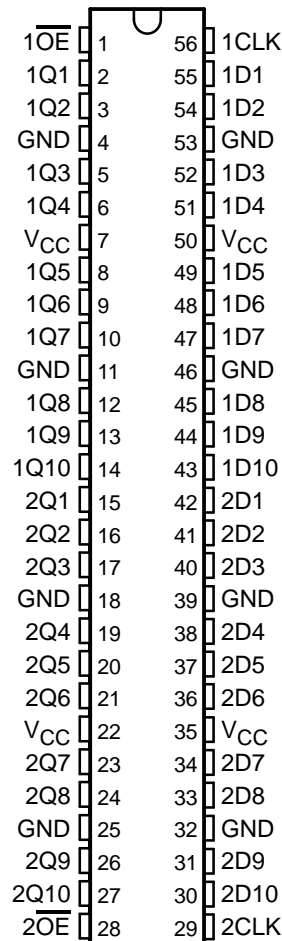
A buffered output-enable (\overline{OE}) input can be used to place the ten outputs in either a normal logic state (high or low level) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

\overline{OE} does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When V_{CC} is between 0 and 1.2 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.2 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ALVTH16821 . . . WD PACKAGE
SN74ALVTH16821 . . . DGG, DGV, OR DL PACKAGE
(TOP VIEW)



PRODUCT PREVIEW



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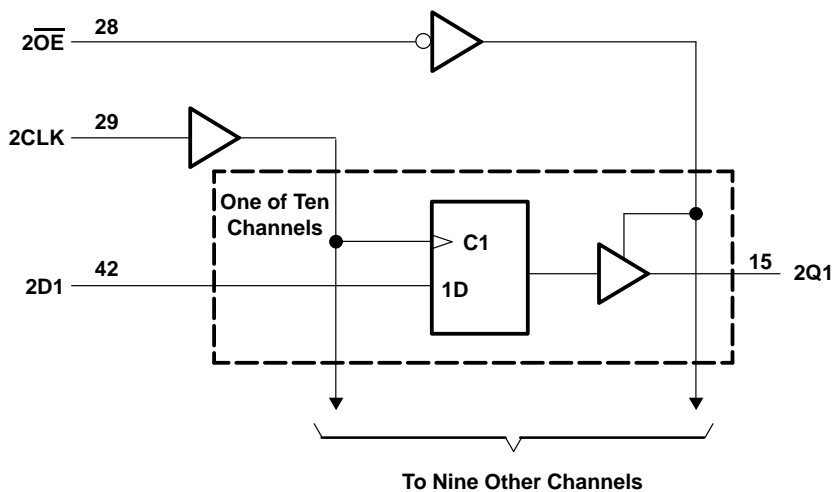
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The SN74ALVTH16821 is available in TI's thin very small-outline package (DGV), which provides the same I/O pin count and functionality of standard Widebus packages in less than half the printed circuit board area.

The SN54ALVTH16821 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALVTH16821 is characterized for operation from -40°C to 85°C .

INPUTS			OUTPUT Q
OE	CLK	D	
L	↑	H	H
L	↑	L	L
L	H or L	X	Q ₀
H	X	X	Z



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O (see Note 1)	–0.5 V to 7 V
Output current in the low state, I_O : SN54ALVTH16821	96 mA
SN74ALVTH16821	128 mA
Output current in the high state, I_O : SN54ALVTH16821	–48 mA
SN74ALVTH16821	–64 mA
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DGG package	1 W
DGV package	1 W
DL package	1.4 W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*.

recommended operating conditions, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (see Note 3)

		SN54ALVTH16821		SN74ALVTH16821		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	2.3	2.7	2.3	2.7	V
V_{IH}	High-level input voltage	1.7		1.7		V
V_{IL}	Low-level input voltage		0.7		0.7	V
V_I	Input voltage	0	5.5	0	5.5	V
I_{OH}	High-level output current		–6		–8	mA
I_{OL}	Low-level output current		6		8	mA
	Low-level output current; current duty cycle $\leq 50\%$; $f \geq 1\text{ KHz}$		18		24	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled			10	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.

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recommended operating conditions, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (see Note 3)

			SN54ALVTH16821		SN74ALVTH16821		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		3	3.6	3	3.6	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	5.5	0	5.5	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			24		32	mA
	Low-level output current; current duty cycle $\leq 50\%$; $f \geq 1\text{ KHz}$			48		64	
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 3: Unused control inputs must be held high or low to prevent them from floating.

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**electrical characteristics over recommended operating free-air temperature range,
 $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)**

PARAMETER	TEST CONDITIONS		SN54ALVTH16821			SN74ALVTH16821			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 2.3\text{ V}$, $I_I = -18\text{ mA}$				-1.2			-1.2	V
V_{OH}	$V_{CC} = 2.3\text{ V to } 2.7\text{ V}$, $I_{OH} = -100\text{ }\mu\text{A}$		$V_{CC}-0.2$			$V_{CC}-0.2$			V
	$V_{CC} = 2.3\text{ V}$	$I_{OH} = -6\text{ mA}$	1.7						
		$I_{OH} = -8\text{ mA}$				1.7			
V_{OL}	$V_{CC} = 2.3\text{ V to } 2.7\text{ V}$, $I_{OL} = 100\text{ }\mu\text{A}$				0.2			0.2	V
	$V_{CC} = 2.3\text{ V}$	$I_{OL} = 6\text{ mA}$			0.5				
		$I_{OL} = 8\text{ mA}$						0.5	
		$I_{OL} = 18\text{ mA}$			0.5				
		$I_{OL} = 24\text{ mA}$						0.5	
I_I	$V_{CC} = 2.7\text{ V}$, $V_I = \text{GND}$	Control inputs			± 1			± 1	μA
	$V_{CC} = 0\text{ or } 2.7\text{ V}$, $V_I = 2.7\text{ V}$				10			10	
	$V_{CC} = 2.7\text{ V}$	Data inputs			10			10	
					-5			-5	
I_{off}	$V_{CC} = 0$, $V_I\text{ or } V_O = 0\text{ to } 4.5\text{ V}$				± 100			± 100	μA
$I_{I(\text{hold})}$	$V_{CC} = 2.3\text{ V}$	$V_I = 0.7\text{ V}$	Data inputs		90			90	μA
		$V_I = 1.7\text{ V}$			75			75	
	$V_{CC} = 2.7\text{ V}^\ddagger$, $V_I = 0\text{ to } 2.7\text{ V}$								
I_{EX}^\S	$V_{CC} = 2.3\text{ V}$, $V_O = 3.6\text{ V}$								μA
$I_{OZ(\text{PU/PD})}^\P$	$V_{CC} \leq 1.2\text{ V}$, $V_O = 0.5\text{ V to } V_{CC}$, $V_I = \text{GND or } V_{CC}$, $\overline{OE} = \text{don't care}$				± 100			± 100	μA
I_{OZH}	$V_{CC} = 2.7\text{ V}$, $V_O = 2.7\text{ V}$, $V_I = 0.7\text{ V or } 1.7\text{ V}$				5			5	μA
I_{OZL}	$V_{CC} = 2.7\text{ V}$, $V_O = 0\text{ V}$, $V_I = 0.7\text{ V or } 1.7\text{ V}$				-5			-5	μA
I_{CC}	$V_{CC} = 2.7\text{ V}$, $V_I = V_{CC}\text{ or GND}$	$I_O = 0$, Outputs high		0.04	0.09		0.04	0.09	mA
		Outputs low		2.3	4.5		2.3	4.5	
		Outputs disabled		0.04	0.09		0.04	0.09	
C_i	$V_{CC} = 2.5\text{ V}$, $V_I = 2.5\text{ V or } 0$				3			3	pF
C_o	$V_{CC} = 2.5\text{ V}$, $V_O = 2.5\text{ V or } 0$				9			9	pF

† All typical values are at $V_{CC} = 2.5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ Current into an output in the high state when $V_O > V_{CC}$

¶ High-impedance state during power up/high-impedance state during power down

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electrical characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 2)

PARAMETER	TEST CONDITIONS		SN54ALVTH16821			SN74ALVTH16821			UNIT
			MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}	$V_{CC} = 3 \text{ V}$, $I_I = -18 \text{ mA}$				-1.2			-1.2	V
V_{OH}	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$, $I_{OH} = -100 \mu\text{A}$		$V_{CC}-0.2$			$V_{CC}-0.2$			V
	$V_{CC} = 3 \text{ V}$	$I_{OH} = -24 \text{ mA}$	2						
		$I_{OH} = -32 \text{ mA}$				2			
V_{OL}	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$, $I_{OL} = 100 \mu\text{A}$				0.2			0.2	V
	$V_{CC} = 3 \text{ V}$	$I_{OL} = 16 \text{ mA}$						0.4	
		$I_{OL} = 24 \text{ mA}$			0.5				
		$I_{OL} = 32 \text{ mA}$						0.5	
		$I_{OL} = 48 \text{ mA}$			0.55				
		$I_{OL} = 64 \text{ mA}$						0.55	
I_I	$V_{CC} = 3.6 \text{ V}$, $V_I = V_{CC}$ or GND	Control inputs			± 1			± 1	μA
	$V_{CC} = 0$ or 3.6 V , $V_I = 5.5 \text{ V}$				10			10	
	$V_{CC} = 3.6 \text{ V}$	$V_I = 5.5 \text{ V}$			20			20	
		$V_I = V_{CC}$			10			10	
		$V_I = 0$			-5			-5	
I_{off}	$V_{CC} = 0$, V_I or $V_O = 0$ to 4.5 V				± 100			± 100	μA
$I_{I(\text{hold})}$	$V_{CC} = 3 \text{ V}$	$V_I = 0.8 \text{ V}$	Data inputs		75			75	μA
		$V_I = 2 \text{ V}$			-75			-75	
	$V_{CC} = 3.6 \text{ V}^\ddagger$, $V_I = 0$ to 3.6 V				± 500			± 500	
I_{EX}^\S	$V_{CC} = 3 \text{ V}$, $V_O = 5.5 \text{ V}$				125			125	μA
$I_{OZ(\text{PU/PD})}^\P$	$V_{CC} \leq 1.2 \text{ V}$, $V_O = 0.5 \text{ V to } V_{CC}$, $V_I = \text{GND or } V_{CC}$, $\overline{OE} = \text{don't care}$				± 100			± 100	μA
I_{OZH}	$V_{CC} = 3.6 \text{ V}$, $V_O = 3 \text{ V}$, $V_I = 0.8 \text{ V or } 2 \text{ V}$				5			5	μA
I_{OZL}	$V_{CC} = 3.6 \text{ V}$, $V_O = 0.5 \text{ V}$, $V_I = 0.8 \text{ V or } 2 \text{ V}$				-5			-5	μA
I_{CC}	$V_{CC} = 3.6 \text{ V}$, $V_I = V_{CC}$ or GND $I_O = 0$,	Outputs high		0.07	0.09		0.07	0.09	mA
		Outputs low		3.2	5		3.2	5	
		Outputs disabled		0.07	0.09		0.07	0.09	
$\Delta I_{CC}^\#$	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$, One input at $V_{CC} - 0.6 \text{ V}$, Other inputs at V_{CC} or GND				0.2			0.2	mA
C_i	$V_{CC} = 3.3 \text{ V}$, $V_I = 3.3 \text{ V or } 0$				3			3	pF
C_o	$V_{CC} = 3.3 \text{ V}$, $V_O = 3.3 \text{ V or } 0$				9			9	pF

† All typical values are at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ Current into an output in the high state when $V_O > V_{CC}$

¶ High-impedance state during power up/high-impedance state during power down

This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

			SN54ALVTH16821		SN74ALVTH16821		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency		0	200	0	200	MHz
t_w	Pulse duration, CLK high or low		1.5		1.5		ns
t_{su}	Setup time, data before CLK \uparrow	High or low	2		2		ns
t_h	Hold time, data after CLK \uparrow	High or low	0.3		0.3		ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 2)

			SN54ALVTH16821		SN74ALVTH16821		UNIT
			MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency		0	300	0	300	MHz
t_w	Pulse duration, CLK high or low		1.5		1.5		ns
t_{su}	Setup time, data before CLK \uparrow	High or low	1.7		1.7		ns
t_h	Hold time, data after CLK \uparrow	High or low	0		0		ns

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALVTH16821		SN74ALVTH16821			UNIT
			MIN	MAX	MIN	TYP \dagger	MAX	
f_{max}			200		200			MHz
t_{pd}	CLK	Q	1.5	5.7	1.5	2.8	5.2	ns
t_{en}	$\overline{\text{OE}}$	Q	2	5.5	2	2.9	5	ns
t_{dis}	$\overline{\text{OE}}$	Q	2.5	6.5	2.5	4.1	6	ns

\dagger All typical values are at $V_{CC} = 2.5\text{ V}$, $T_A = 25^\circ\text{C}$.

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALVTH16821		SN74ALVTH16821			UNIT
			MIN	MAX	MIN	TYP \ddagger	MAX	
f_{max}			300		300			MHz
t_{pd}	CLK	Q	1.5	4.2	1.5	2.3	3.7	ns
t_{en}	$\overline{\text{OE}}$	Q	1.2	4.1	1.2	2.2	3.6	ns
t_{dis}	$\overline{\text{OE}}$	Q	2	5.5	2	3.4	5	ns

\ddagger All typical values are at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

PRODUCT PREVIEW



SN54ALVTH16821, SN74ALVTH16821

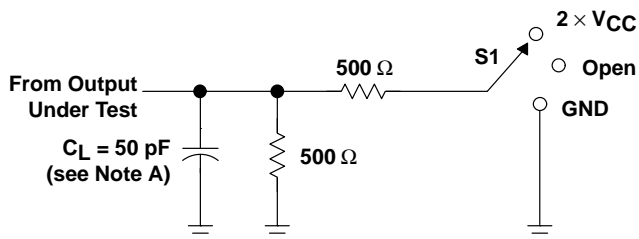
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WITH 3-STATE OUTPUTS

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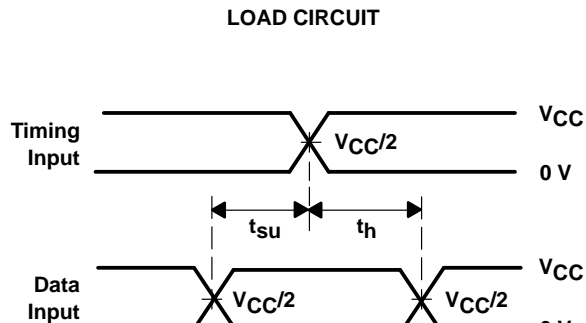
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$

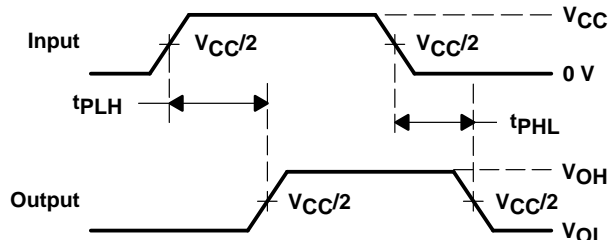


LOAD CIRCUIT

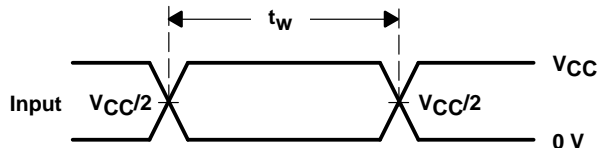
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 $\times V_{CC}$
t_{PHZ}/t_{PZH}	GND



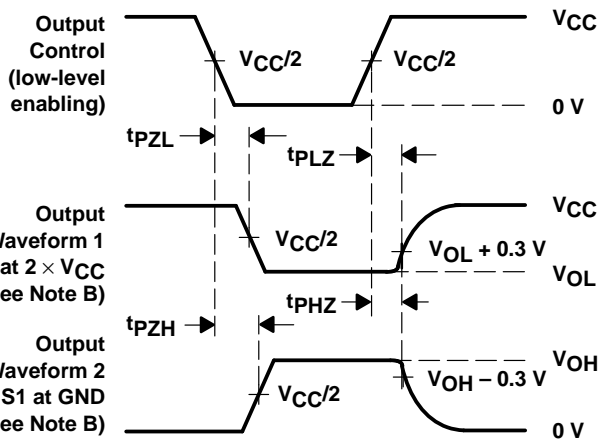
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

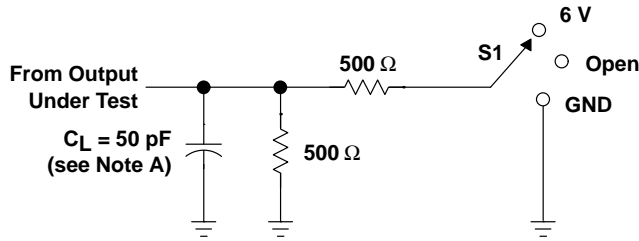
Figure 1. Load Circuit and Voltage Waveforms

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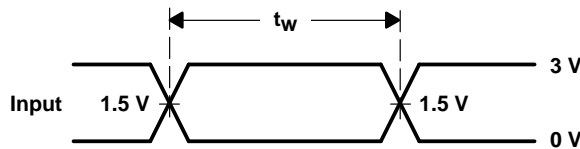
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$$

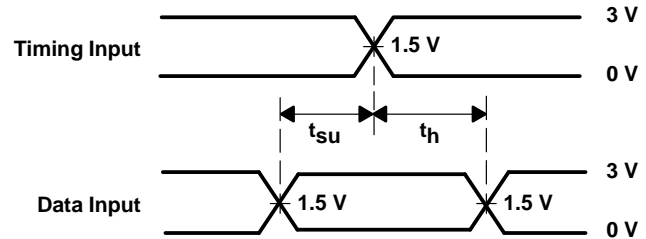


LOAD CIRCUIT

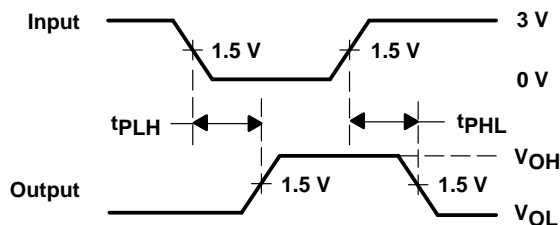
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



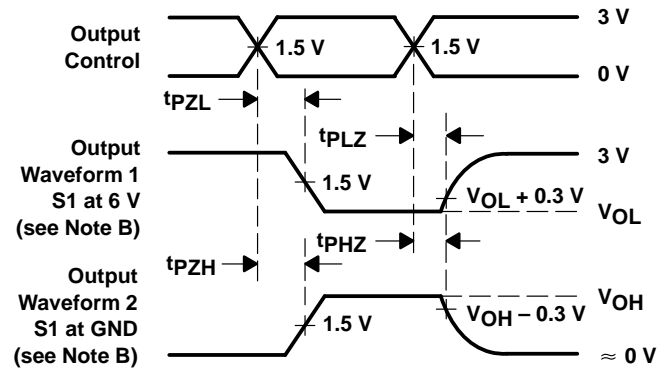
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

PRODUCT PREVIEW

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